

GX5 **G893-SD1-AAX5**

Let Hyperscalers meet your bespoke requirements!

Start customizing your GX5 | G893-SD1-AAX5 today!

- NVIDIA HGX™ B200 8-GPU
- 1,800GB/s GPU-to-GPU bandwidth with NVIDIA® NVLink™ and NVSwitch™
- Dual 5th/4th Gen Intel® Xeon® Scalable Processors
- Dual Intel® Xeon® CPU Max Series
- 8-Channel DDR5 RDIMM, 32 x DIMMs
- **Dual ROM Architecture**
- Compatible with NVIDIA® BlueField®-3 DPUs and ConnectX®-7 NICs
- 2 x 10Gb/s LAN ports via Intel® X710-AT2
- 2 x M.2 slots with PCIe Gen3 x2 and x1 interface
- 8 x 2.5" Gen5 NVMe/SATA hot-swap bays
- 4 x FHHL dual-slot PCIe Gen5 x16 slots
- 8 x FHHL single-slot PCIe Gen5 x16 slots
- 12 x 3000W 80 PLUS Titanium redundant power supplies

About **Hyperscalers**



World's First Open



Free Of Propritery Software Lock-Ins



Free Of Propritery Hardware Lock-Ins



US Stock



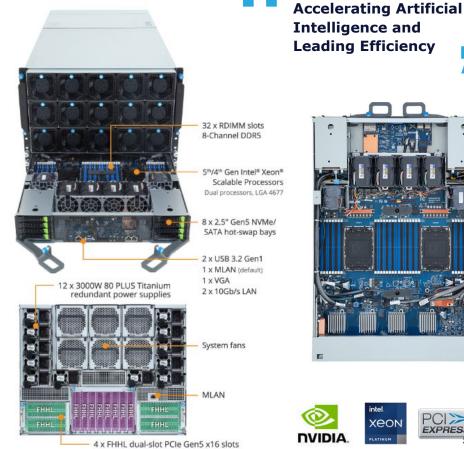
Full US Warranty



100% Channel Distributor



Metro Days





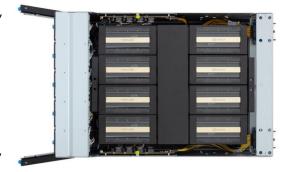






HPC/AI Server - 5th/4th Gen Intel® Xeon® Scalable - 8U **DP NVIDIA HGX™ B200 8-GPU**

- 8-GPU platform for generative AI, HPC, and data analytics.
- Blackwell Tensor Core GPUs with 1.4 TB memory & 64 TB/s bandwidth.
- 15× faster AI inference; 12× lower cost & energy.
- Advanced networking up to 400 Gb/s.
- BlueField-3 DPUs for cloud networking, storage, security, and GPU elasticity.



Reliable, Efficient, and Secure Design

8 x FHHL single-slot PCIe Gen5 x16 slots

- Power Efficiency: Auto fan control for optimal cooling.
- High Availability: SmaRT for power loss; dual ROM for backup boot.
- Security: Optional TPM 2.0 for hardware-based protection.
- User-Friendly: Tool-less drive bays.















GX5 | G893-SD1-AAX5 Specifications

Processor	Processor Type:
	5th Gen Intel® Xeon® Scalable Processors 4th Gen Intel® Xeon® Scalable Processors
	Intel® Xeon® CPU Max Series
	Motherboard: MSB3-PE0
	Max. TDP Support: 350W Number of Processors: 2 Processors
	Internal Interconnect: 16 GT/s
	L3 Cache: Up to 112.5MB
Form Factor	- 8U
Dimensions	W x H x D (mm): 447 x 351 x 923
Socket	2 x LGA 4677 Socket E
Chipset	Intel® C741 Series
Storage	Front hot-swap: 8 x 2.5" Gen5 NVMe/SATA (NVMe from PEX89104) Internal M.2:
	1 x M.2 (2280/22110), PCIe Gen3 x2, from PCH
	1 x M.2 (2280/22110), PCIe Gen3 x1, from PCH
	SAS: N/A
	RAID: Intel® SATA RAID 0/1/10/5
Memory	Total Slots: 32 x DIMM slots
	Memory Type: DDR5 memory supported (8-Channel memory per
	processor) Speed:
	5th Gen Xeon: RDIMM: Up to 5600 MT/s (1DPC), 4400 MT/s (2DPC)
	4th Gen Xeon: RDIMM: Up to 4800 MT/s (1DPC), 4400 MT/s (2DPC)
	Xeon Max Series: RDIMM: Up to 4800 MT/s (1DPC), 4400 MT/s (2DPC)
GPU	Modular GPU: NVIDIA HGX™ B200 with 8 x SXM GPUs
Expansion Slot	PCIe Bridge Board - CBG76:
	- 8 x FHHL x16 (Gen5 x16), from PEX89104
	PCIe Bridge Board - CPBG045 x 2:
	- 4 x FHHL x16 (Gen5 x16), from PEX89048
Front I/O	Front (I/O board - CFPG540):
	I/O board - CFPG540:
	2 v LICD 2 2 Con1 norte (Tuno A)
	2 x USB 3.2 Gen1 ports (Type-A)
	1 x VGA port
	1 x VGA port 2 x RJ45 ports 1 x MLAN port (default)
	1 x VGA port 2 x RJ45 ports
	1 x VGA port 2 x RJ45 ports 1 x MLAN port (default)
	1 x VGA port 2 x RJ45 ports 1 x MLAN port (default) 1 x Power button with LED
	1 x VGA port 2 x RJ45 ports 1 x MLAN port (default) 1 x Power button with LED 1 x ID button with LED
	1 x VGA port 2 x RJ45 ports 1 x MLAN port (default) 1 x Power button with LED 1 x ID button with LED 1 x NMI button

Backplane Board	Speed and bandwidth: PCIe Gen5 x4 or SATA 6Gb/s
Power Supply	12 x 3000W 80 PLUS Titanium redundant power supplies AC Input: - 115-127V~/ 14.2A, 50-60Hz - 200-220V~/ 15.8A, 50-60Hz - 220-240V~/ 14.9A, 50-60Hz DC Input: (Only for China) - 240Vdc/ 14A DC Output: - Max 1450W/ 115-127V~ +54V/ 26.6A, +12Vsb/ 3A - Max 2900W/ 200-220V~ +54V/ 53.4A, +12Vsb/ 3A - Max 3002.4W/ 220-240V~ or 240V dc Input +54V/ 55.6A, +12Vsb/ 3A
Onboard Storage	(2) 2280 PCIe M.2 for Booting OS
Fan	Motherboard: 2 x 60x60x56mm (24,600rpm) 4 x 60x60x76mm (21,800rpm) PCIe slots: 4 x 80x80x56mm (15,500rpm) GPU tray: 15 x 80x80x80mm (16,400rpm)
Video	Integrated in ASPEED® AST2600 - 1 x VGA port
System Management	ASPEED® AST2600 Baseboard Management Controller GIGABYTE Management Console web interface
Rear I/O	MLAN board - CDB66: 1 x MLAN port
Operating Environment	Operating temperature: 10°C to 35°C Operating humidity: 8%-80% (non-condensing) Non-operating temperature: -40°C to 60° C Non-operating humidity: 20%-95% (non-condensing)
ТРМ	Security Modules: 1 x TPM header with SPI interface

Authorised Hyperscalers Partner



About Hyperscalers

Hyperscalers is the world's first open Original Equipment Manufacturer offering proprietary-free alterative to traditional Tier 1 OEM vendors.

Hereto to solve Information technology's complexity, Hyperscalers developed the IP Appliance Design Process. Which is basically a process along with a utility, being the Appliance Optimizer Utility, which together, assists service providers 'productize' delivery of their Digital-IP.

Technology Partners



Micron













- Optional TPM2.0 kit: CTM010

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Opearating out of USA, India, EU www.hyperscalers.com